

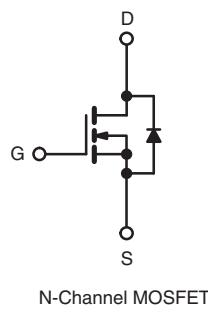
E Series Power MOSFET

PRODUCT SUMMARY	
V _{DS} (V) at T _J max.	650
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.28
Q _g max. (nC)	76
Q _{gs} (nC)	11
Q _{gd} (nC)	17
Configuration	Single

FEATURES

- Low figure-of-merit (FOM) R_{on} x Q_g
- Low input capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Q_g)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT

Thin-Lead TO-220 FULLPAK


APPLICATIONS

- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer
 - Adaptors
 - Televisions
 - Game console
- Computing
 - Adaptors
 - ATX power supply

ORDERING INFORMATION

Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA15N60E-E3

ABSOLUTE MAXIMUM RATINGS (T_C = 25 °C, unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	600	V
Gate-Source Voltage	V _{GS}	± 30	
Continuous Drain Current (T _J = 150 °C) ^e	V _{GS} at 10 V	I _D	A
	T _C = 25 °C	15	
	T _C = 100 °C	9.6	
Pulsed Drain Current ^a	I _{DM}	39	
Linear Derating Factor		0.27	W/°C
Single Pulse Avalanche Energy ^b	E _{AS}	102	mJ
Maximum Power Dissipation	P _D	34	W
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	V _{DS} = 0 V to 80 % V _{DS}	dV/dt	
Reverse Diode dV/dt ^d		70	V/ns
		7.7	
Soldering Recommendations (Peak Temperature) ^c	for 10 s		°C

Notes

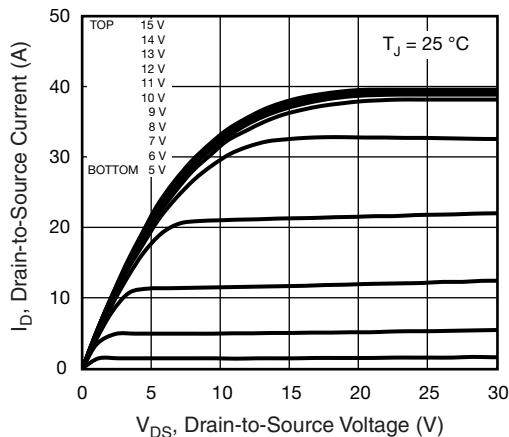
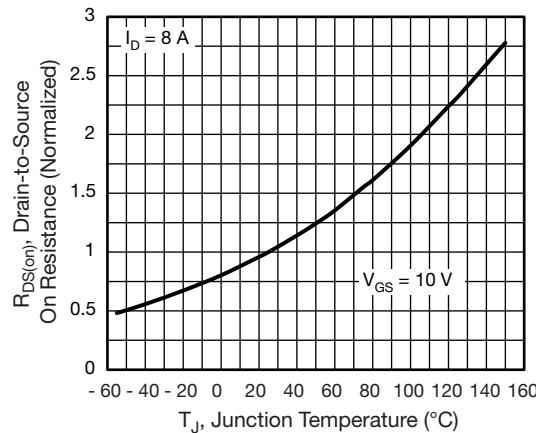
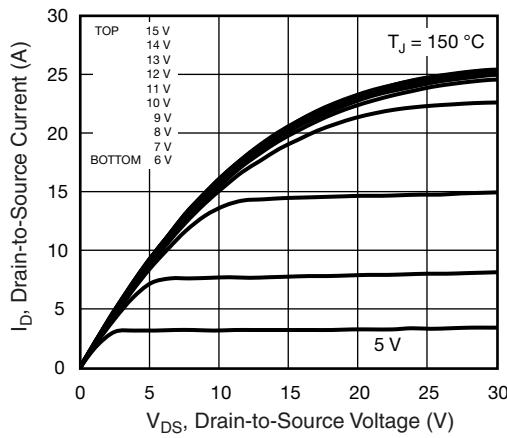
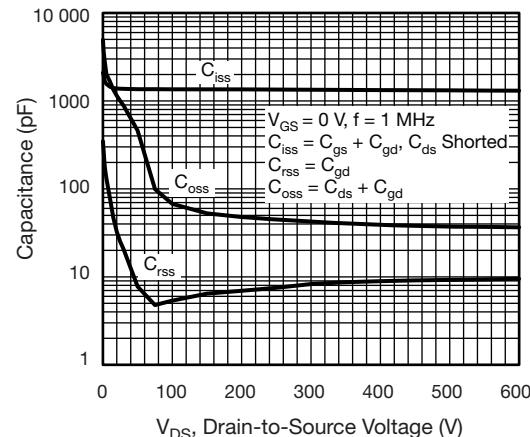
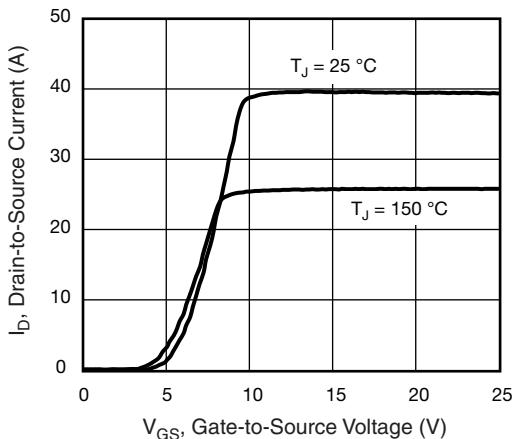
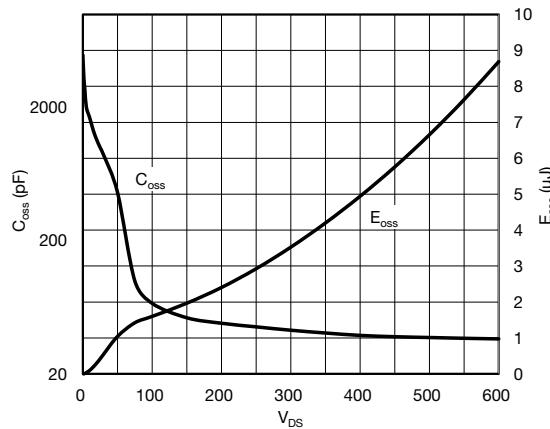
- Repetitive rating; pulse width limited by maximum junction temperature.
- V_{DD} = 50 V, starting T_J = 25 °C, L = 11.6 mH, R_g = 25 Ω, I_{AS} = 4.2 A.
- 1.6 mm from case.
- I_{SD} ≤ I_D, dI/dt = 100 A/μs, starting T_J = 25 °C.
- Limited by maximum junction temperature.

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R_{thJA}	-	65	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	3.7	°C/W

SPECIFICATIONS ($T_J = 25$ °C, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static								
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0$ V, $I_D = 250$ μA		600	-	-	V	
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to 25 °C, $I_D = 1$ mA		-	0.71	-	V/°C	
Gate-Source Threshold Voltage (N)	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250$ μA		2	-	4	V	
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 20$ V		-	-	± 100	nA	
		$V_{GS} = \pm 30$ V		-	-	± 1	μA	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 600$ V, $V_{GS} = 0$ V		-	-	1		
		$V_{DS} = 480$ V, $V_{GS} = 0$ V, $T_J = 125$ °C		-	-	10	μA	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10$ V	$I_D = 8$ A	-	0.23	0.28	Ω	
Forward Transconductance	g_{fs}	$V_{DS} = 30$ V, $I_D = 8$ A		-	4.6	-	S	
Dynamic								
Input Capacitance	C_{iss}	$V_{GS} = 0$ V, $V_{DS} = 100$ V, $f = 1$ MHz		-	1350	-	pF	
Output Capacitance	C_{oss}			-	70	-		
Reverse Transfer Capacitance	C_{rss}			-	5	-		
Effective Output Capacitance, Energy Related ^a	$C_{o(er)}$	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	53	-		
Effective Output Capacitance, Time Related ^b	$C_{o(tr)}$			-	177	-		
Total Gate Charge	Q_g	$V_{GS} = 10$ V	$I_D = 8$ A, $V_{DS} = 480$ V	-	38	76	nC	
Gate-Source Charge	Q_{gs}			-	11	-		
Gate-Drain Charge	Q_{gd}			-	17	-		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 480$ V, $I_D = 8$ A, $V_{GS} = 10$ V, $R_g = 9.1$ Ω		-	17	34	ns	
Rise Time	t_r			-	51	77		
Turn-Off Delay Time	$t_{d(off)}$			-	35	70		
Fall Time	t_f			-	33	66		
Gate Input Resistance	R_g	$f = 1$ MHz, open drain		-	0.86	-	Ω	
Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current	I_S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	15	A	
Pulsed Diode Forward Current	I_{SM}			-	-	60		
Diode Forward Voltage	V_{SD}	$T_J = 25$ °C, $I_S = 8$ A, $V_{GS} = 0$ V		-	-	1.2	V	
Reverse Recovery Time	t_{rr}	$T_J = 25$ °C, $I_F = I_S = 8$ A, $dl/dt = 100$ A/μs, $V_R = 20$ V		-	410	-	ns	
Reverse Recovery Charge	Q_{rr}			-	5.4	-		
Reverse Recovery Current	I_{RRM}			-	21	-	A	

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics

Fig. 4 - Normalized On-Resistance vs. Temperature

Fig. 2 - Typical Output Characteristics

Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 3 - Typical Transfer Characteristics

Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

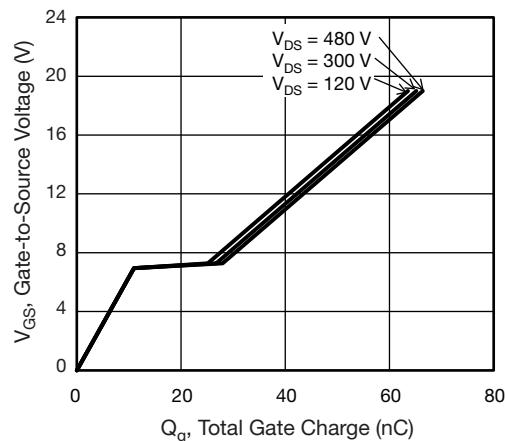


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

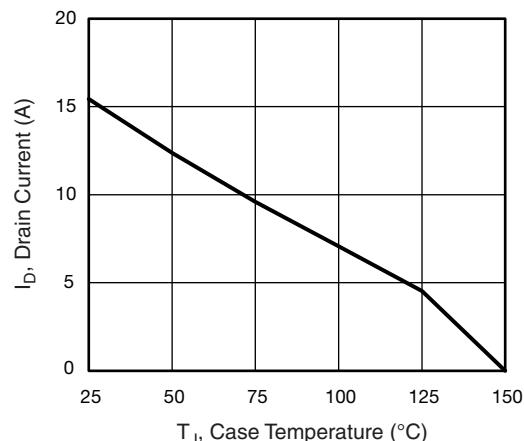


Fig. 10 - Maximum Drain Current vs. Case Temperature

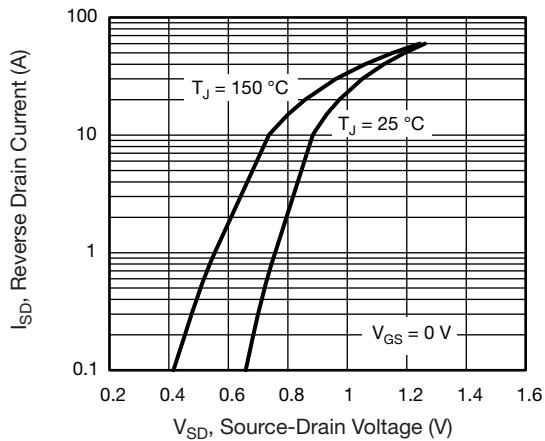


Fig. 8 - Typical Source-Drain Diode Forward Voltage

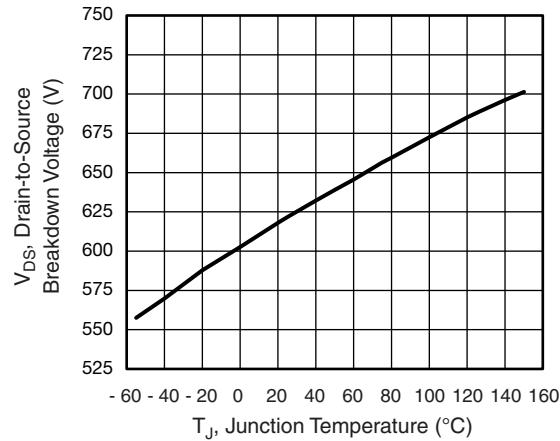


Fig. 11 - Temperature vs. Drain-to-Source Voltage

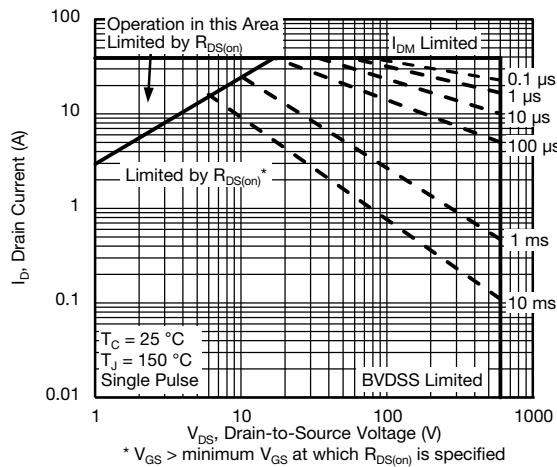


Fig. 9 - Maximum Safe Operating Area

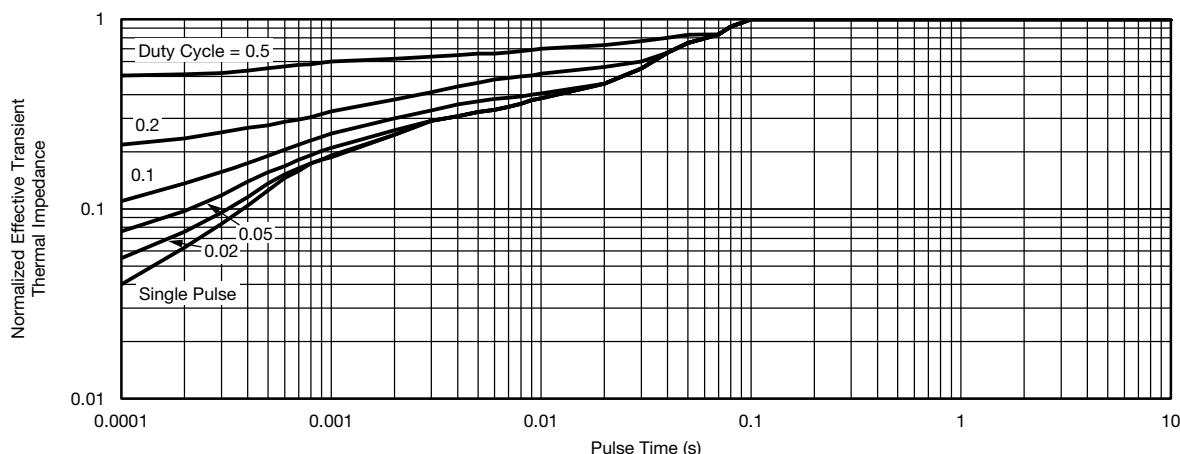


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

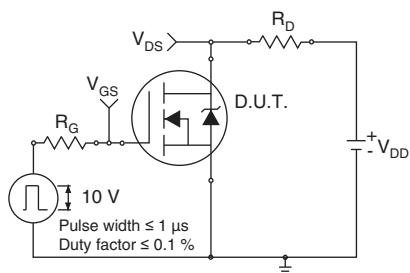


Fig. 13 - Switching Time Test Circuit

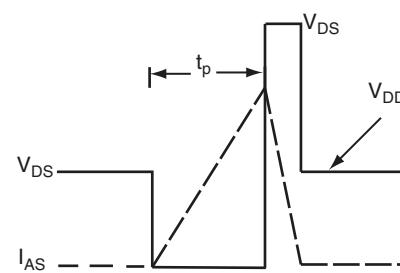


Fig. 16 - Unclamped Inductive Waveforms

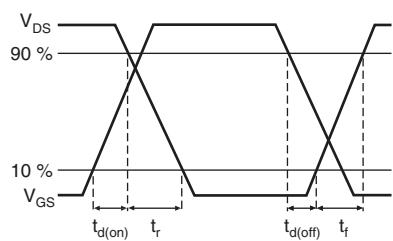


Fig. 14 - Switching Time Waveforms

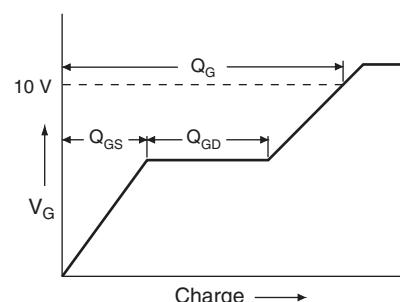


Fig. 17 - Basic Gate Charge Waveform

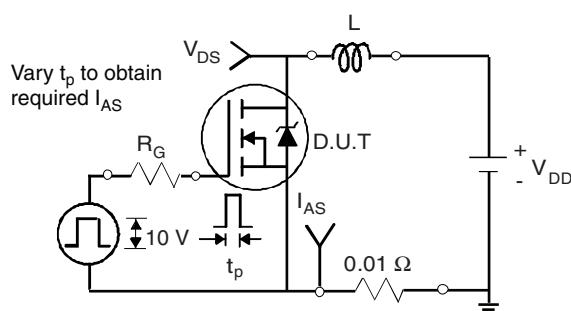


Fig. 15 - Unclamped Inductive Test Circuit

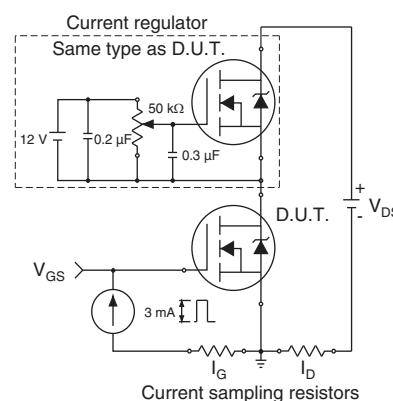
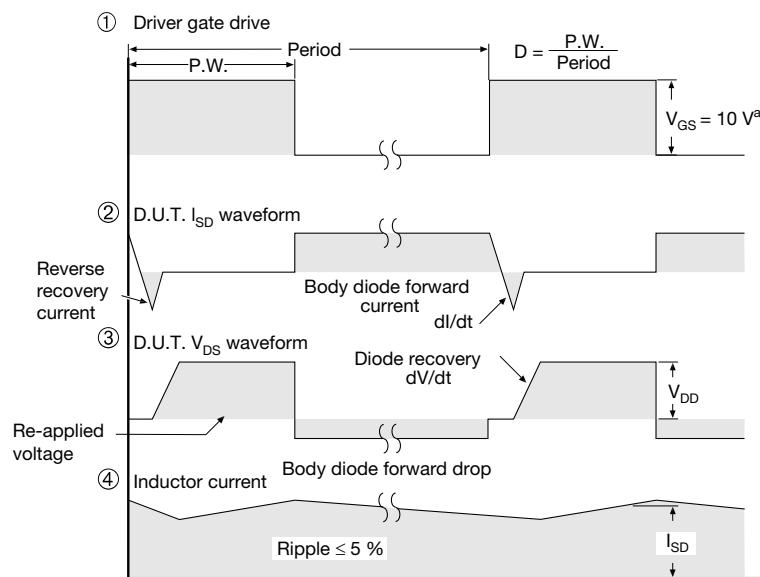
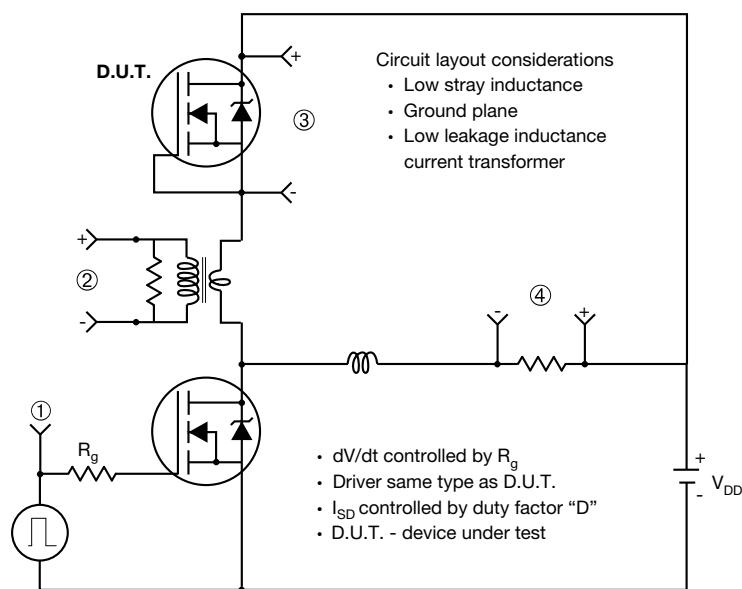


Fig. 18 - Gate Charge Test Circuit

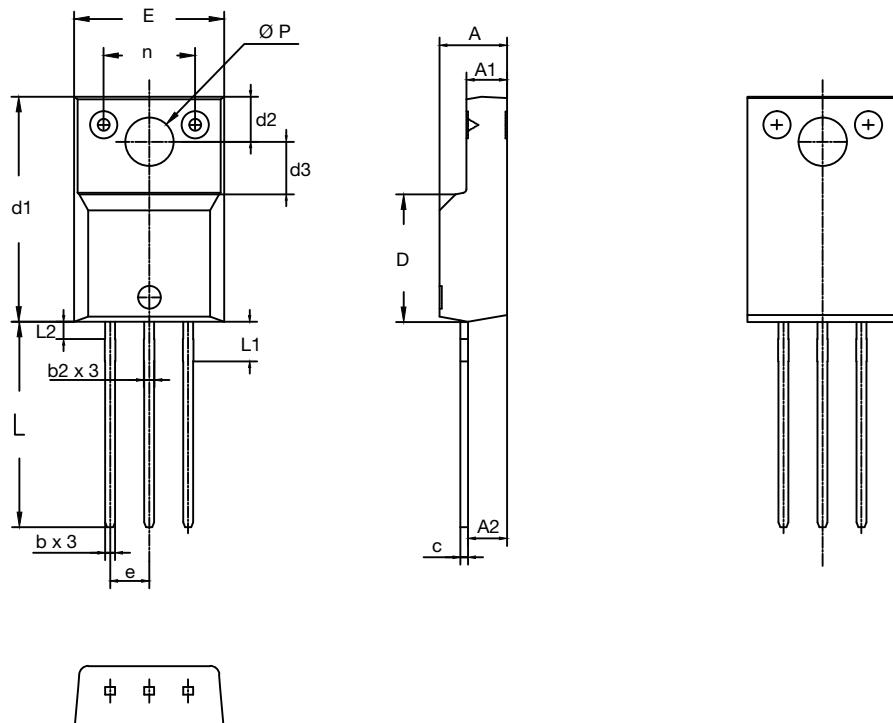
Peak Diode Recovery dV/dt Test Circuit

Note

a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead



SYMBOL	DIMENSIONS			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.50	2.70	0.098	0.106
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
c	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.40	3.60	0.134	0.142
E	9.70	10.30	0.382	0.406
e	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	2.50	2.80	0.098	0.110
L2	-	1.20	-	0.047
n	6.05	6.15	0.238	0.242
Ø P	3.00	3.40	0.118	0.134

ECN: T16-0549-Rev. C, 12-Sep-16
DWG: 6021

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